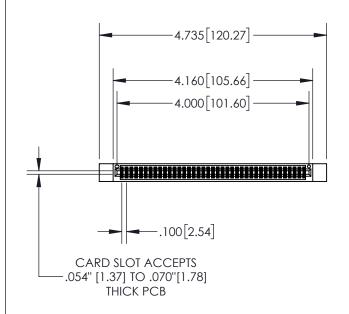
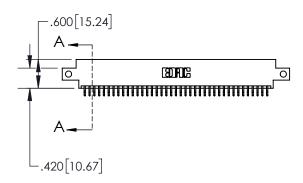
Contact Dimensions:

556-Extender Board Bend (Code 520 Contacts)
See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions





- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

1

.330[8.38] CARD SLOT				
-	.370[9.40]			
	SECTION A-A			
	.160[4.06] POINT OF CONTACT			
	- .200[5.08]			

845/895 SEI	RIES HIGH TEMP	CARD EDG	E CONNECTOR
PART NUME	BER: 845-078-55	6-812	



	ACAD REFERENCE NO. 845-ENG-MASTER				
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017			
	CHECKED:	DATE:			
	SCALE: 1:2	SHEET 1 OF 2			
D	DRAWING NUMBER	ISSUE			
	845-ENG-MASTER	1			







- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE: MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

845-ENG-MASTER